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Application Number

O9/786,787

Filing Date

Sep. 7, 1999

First Named Inventor

Martin A Cotton

TRANSMITTAL FORM

(to be used for all correspondence after initial filing)

Total Number of Pages in This Submission

Filing Date Sep. 7, 1999

First Named Inventor Martin A. Cotton

Art Unit 2831

Examiner Name Kamand Cuneo

Attorney Docket Number 8245.016

ENCLOSURES (Check all that apply)							
	Fee Trans	smittal Form		Drawing(s)			After Allowance Communication to TC
	☐ Fe	ee Attached		Licensing-related Papers			Appeal Communication to Board of Appeals and Interferences
Amendment/Reply  After Final  Affidavits/declaration(s)  Extension of Time Request  Express Abandonment Request  Information Disclosure Statement  Certified Copy of Priority Document(s)  Reply to Missing Parts/ Incomplete Application  Reply to Missing Parts  under 37 CFR 1.52 or 1.53		Petition Petition to Convert to a Provisional Application Power of Attorney, Revocation of POA, Change of Correspondence Address  Terminal Disclaimer  Request for Refund  CD, Number of CD(s)  Landscape Table on CD  Remarks  1. Transmittal Form (1 page); 2. Request for Certificate of Correction 3. Certificate of Correction (1 page) in 4. Copy of Office Communication, date 5. Postcard.		duplicate;			
		SIGNA	TURE	OF APPLICANT, AT	ORNEY, O	RAG	ENT
DUNLAP, GODDING & ROGERS, P.C.							
Signature		Mart					
Printed name		ķ	Chris	stopher W. Corl	oett		
Date		July 27,	2006		Reg. No.		36,109

I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below: \*\*\* SENT BY EXPRESS MAIL No. EL971032108US, DATED 07/27/09 \*\*\*

Signature

Christopher W. Corbett

Date

July 27, 2006

This collection of information is required by 37 CFR 1.5. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11 and1.14. This collection is estimated to 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

EXPRESS MAIL NO.: EL 971032108 US

DATE DEPOSITED: July 27, 2006

**PATENT** 

JUL 2 7 2006

#### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Number:

US 6,713,685 B1

Issued:

March 30, 2004

Name of Patentee: Martin A. Cotton

Title of Invention:

NON-CIRCULAR MICRO-VIA

**Commissioner for Patents** 

P.O. Box 1450, Alexandria, VA 22313-1450

**Decision and Certificate of Correction** 

Branch of the Patent Issue Division

# REQUEST FOR CERTIFICATE OF CORRECTION OF PATENT FOR PTO AND/OR APPLICANT'S MISTAKES (37 CFR 1.322(a) and 1.323)

#### Enclosed are:

1 sheet of Form PTO-1050 (Amended), in duplicate, with at least one copy being [X] suitable for printing.

Pre-addressed Postal Card

#### **PTO ERRORS**

The exact page and line number in the application file are:

The following three patents were cited by the Examiner in the Office Communication dated 10/03/2001, (attached as Exhibit A) but these cited references were not included in the "References Cited" when the patent was issued. Therefore, we respectfully request a Certificate of Correction for the following:

On the first page, under "References Cited U.S. Patent Documents": Insert the following references:

5,414,222 A *	5/1995	Sen et al	174/262
5,522,132 A *	6/1996	Mattei	29/846
5,734,560 A *	3/1998	Kamperman et al	361/774

[X] No fee is submitted herewith.

#### **APPLICANT'S ERRORS**

It is noted that errors appear in this patent of a clerical or typographical nature or a minor character as more fully described below. These errors occurred in good faith and correction thereof does not involve such changes in the patent as would constitute new matter or would require re-examination and a certificate of correction is requested.

The exact page and line number where the mistakes occur in the application are:

[ ] Charge to credit card as shown on the attached credit card information authorization form PTO-2038, in the amount of \$100.00 for this Certificate of Correction. One copy of this sheet is attached.

### **RETURN OF CERTIFICATE**

Please send the Certificate to the undersigned.

Christopher/W. Corbett, Reg. No. 36,109 DUNLAP, CODDING & ROGERS, P.C. P.O. Box 16370, Customer No. 30589

Oklahoma City, Oklahoma 73113

Telephone: 405/607-8600 Facsimile: 405/607-8686

Agent for Applicant

# UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO : 6,713,685 B1

DATED : 03/30/2004

INVENTOR(S): Martin A. Cotton

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the first page, under "References Cited U.S. Patent Documents": Insert the following references:

PATENT NO. 6,713,685 B1

MAILING ADDRESS OF SENDER: Dunlap, Codding & Rogers, P.C. P. O. Box 16370

Oklahoma City, Oklahoma 73113

No. of additional copies

# UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO : 6,713,685 B1

DATED : 03/30/2004

INVENTOR(S): Martin A. Cotton

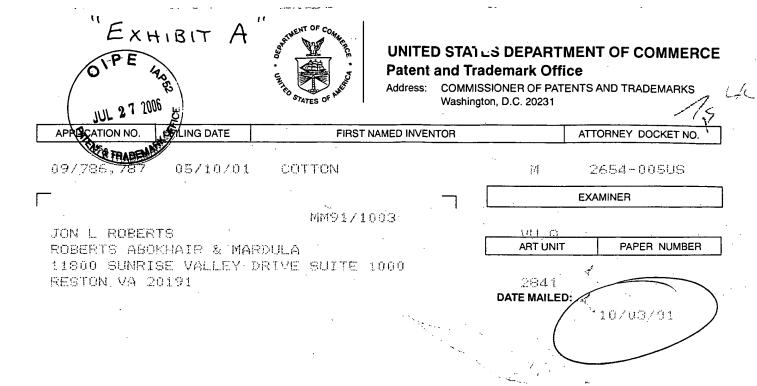
It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the first page, under "References Cited U.S. Patent Documents": Insert the following references:

MAILING ADDRESS OF SENDER: Dunlap, Codding & Rogers, P.C.

P. O. Box 16370 Oklahoma City, Oklahoma 73113 PATENT NO. 6,713,685 B1

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Please find below and/or attached an Office communication concerning this application or proceeding.

**Commissioner of Patents and Trademarks** 

	OIPE 40	•	
	/	Application No.	Applicant(s)
	JUL 27 2006	09/786,787	COTTON, MARTIN A.
	Office Action Summary	Examiner	Art Unit
	O FRADE	Quynh-Nhu H. Vu	2841
Period fo	The MAILING DATE of this communication app or Reply	pears on the cover sheet with th	e correspondence address
THE N - Exter after - If the - If NO - Failu - Any r	ORTENED STATUTORY PERIOD FOR REPL' MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1.1 SIX (6) MONTHS from the mailing date of this communication. period for reply specified above is less than thirty (30) days, a repl period for reply is specified above, the maximum statutory period vere to reply within the set or extended period for reply will, by statute eply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply by within the statutory minimum of thirty (30) will apply and will expire SIX (6) MONTHS for cause the application to become ABANDO	e timely filed  days will be considered timely.  rom the mailing date of this communication.  DNED (35 U.S.C. § 133).
1)	Responsive to communication(s) filed on	•	
2a)□	This action is <b>FINAL</b> . 2b)⊠ Th	is action is non-final.	
3)	Since this application is in condition for allows closed in accordance with the practice under	ance except for formal matters <i>Ex parte Quayle</i> , 1935 C.D. 1	, prosecution as to the merits is 1, 453 O.G. 213.
Dispositi	on of Claims		
4)🖂	Claim(s) 1-26 is/are pending in the application	1.	
	4a) Of the above claim(s) is/are withdra	wn from consideration.	
5)	Claim(s) is/are allowed.		
6)⊠	Claim(s) <u>1-26</u> is/are rejected.		
7)	Claim(s) is/are objected to.		
8)	Claim(s) are subject to restriction and/o	or election requirement.	
Applicati	ion Papers		
,	The specification is objected to by the Examine		
10)[	The drawing(s) filed on is/are: a)□ acce		
	Applicant may not request that any objection to the		
11)	The proposed drawing correction filed on		proved by the Examiner.
_	If approved, corrected drawings are required in re		
12)	The oath or declaration is objected to by the Ex	caminer.	
-	ınder 35 U.S.C. §§ 119 and 120		
13)	Acknowledgment is made of a claim for foreign	n priority under 35 U.S.C. § 11	9(a)-(d) or (f).
a)	☐ All b)☐ Some * c)☐ None of:		
	1. Certified copies of the priority document		
	2. Certified copies of the priority document		
* 5	3. Copies of the certified copies of the prior application from the International Buse the attached detailed Office action for a list	ıreau (PCT Rule 17.2(a)).	
14)⊠ A	Acknowledgment is made of a claim for domest	ic priority under 35 U.S.C. § 11	19(e) (to a provisional application).
	<ul> <li>The translation of the foreign language pro Acknowledgment is made of a claim for domes</li> </ul>		120 and/or 121.
Attachmen	at(s)		AUG 2 ZUUb
2) Notic	ce of References Cited (PTO-892) ce of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449) Paper No(s) _	5) Notice of Inform	mary (PTO-413) Paper No(s) nal Patent Application (PTO-152)
S. Patent and T	rademark Office		Part of Paper No. 5

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#### **DETAILED ACTION**

## Drawings

- 1. The drawings are objected to under 37 CFR 1.83(a). The drawings must show every feature of the invention specified in the claims. Therefore, the recited feature "the trench having a length greater than two times a breath of the trench" of claim 2 must be shown or the feature(s) canceled from the claim(s). No new matter should be entered.
- 2. The drawings are objected to under 37 CFR 1.83(a). The drawings must show every feature of the invention specified in the claims. Therefore, the recited feature of claims 3, 13, 16-17 such as "a first wire trace applied to main surface ... a connection between the first and second wire trace terminal landing pads and the plated through hole" must be shown or the feature(s) canceled from the claim(s). No new matter should be entered.

## Specification

3. The specification is objected to as failing to provide proper antecedent basis for the claimed subject matter. See 37 CFR 1.75(d)(1) and MPEP § 608.01(o). Correction of the following is required: the specification does not support the limitation "the trench having a length greater than two times a breath of the trench", as recited in claim 2. Likewise, the specification does not support the limitations of claims 3, 13 and 16-17 (i.e. a first wire trace having a first through hole, a printed circuit board first insulation layer formed over the first wire trace having second through hole, a second wire trace applied to the insulation layer having a second terminal landing pad with a third through hole having identical geometry to and vertically aligned with the first and second through holes). Furthermore, please clarify specific section in the specification in which applies to claims 3, 13 and 16-17.

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## Claim Rejections - 35 USC § 112

4. The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

5. Claim 9 recites the limitation "the ground plane" in lines 19. There is insufficient antecedent basis for this limitation in the claim.

## Claim Rejections - 35 USC § 102

6. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- (e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.
- 7. Claims 1, 3-4, 13-17 are rejected under 35 U.S.C. 102(b) as being anticipated by Sen et al. [US 5,414,222].

As to claim 1, Sen et al. disclose in Figs. 2-3F a wiring connection structure for printed circuit board, characterized by: a through-hole (24 in Fig. 2 or Figs. 3A-3F) with a convoluted shaped cross section having an interior wall that vertically extends through and intersects and exposes a plurality of wire circuit traces (21, 31) and a plating of conductive material is inherent applied to the interior wall electrically connecting a plurality of wire exposed circuit traces on a plurality of circuit layers.

It has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior

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art apparatus satisfying the claimed structural limitations pertaining to phrase "for interconnecting wiring circuit traces on a plurality of circuit trace layers applied on a plurality of printed circuit board layers and electrically isolated there between by the printed circuit board layers and having a printed circuit board multi-layered structure:. Ex Pane Masham, 2USPQ F.2d 1647 (1987).

As to claims 3-4,13 and 16, Sen et al. disclose in Figs. 2-3F (also see attachment) a wiring connection structure having a first wire circuit trace (31) having a width applied to a main surface (30) and having a first terminal land pad with a terminal width the same as the width of the first wire trace and having a first through hole with a major and minor diameter where in minor diameter where the minor diameter is less than the width of the first trace and the major diameter is elongated and directional along a direction of the terminal landing pad; a printed circuit board first insulating layer (20) formed over the first wire trace having a second through hole (24) having identical geometry and orientation as and vertically aligned with the first through hole and extending to the first wire trace terminal landing pad; and second wire circuit trace (21) applied to the printed circuit board first insulation layer having a second terminal land pad with a third through hole having identical geometry to and aligned with the first through hole, wherein the first, second and third through holes are adjoining and are plated there through with an electrically conductive material forming a plated through hole vertically intersecting the first and second terminal pads and electrically connecting the first wire trace and the second wire trace by a connection between the first and second landing pads and the through hole.

It has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations pertaining to phrase "for interconnecting a plurality of wiring circuit traces applied on a plurality of printed circuit board

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layers and electrically isolated by the printed circuit board layers and having a printed circuit board first layer with a main surface". Ex Pane Masham, 2USPQ F.2d 1647 (1987).

As to claims 14-15, Sen et al. disclose in Fig. 3 wherein the major diameter is at least about twice / three times that of the minor diameter.

As to claim 17, since the method of manufacturing the device is merely a list of steps of forming, these steps must be performed in order to obtain the device (see rejection of claims 13-15 above). Therefore, the method of manufacturing would be inherent to the shown structure of the device.

8. Claims 2, 9-12, 20-23 are rejected under 35 U.S.C. 102(e) as being anticipated by Harada et al. [US 5,966,294].

As to claim 2, Harada et al. disclose in Fig. 3 an EMI shielding structure for a printed circuit board comprising: a trench having a rim about an opening of the trench at a top printed circuit board layer and the trench extending through a plurality of printed circuit board layers to a grounding plane (140) exposing the grounding plane and the trench having an interior wall with a conductive plating material applied over the wall; Harada et al. clearly show the trench having a length greater than two times a breadth of the trench and the wall vertically extends around the perimeter of the printed circuit board and the plating electrically connects to the exposed ground plane and wraps over and laterally extends from the rim forming a lip.

It has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations pertaining to phrase "for shielding wiring circuit traces on a plurality of circuit trace layers applied on a plurality of printed circuit board layers and electrically isolated there between by the printed circuit board layers and

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having a printed circuit board multi layer structure". Ex Pane Masham, 2USPQ F.2d 1647 (1987).

As to claims 9-12, Harada et al. disclose in Fig. 3 a reference plane structure of a printed circuit board comprising: a first wire trace circuit layer (141b, 141c) applied to a main surface; a first printed circuit board-insulating layer formed over the first wire trace circuit layer; a first reference plane (140) applied over the first printed circuit board-insulating layer; a trench having an interior wall and extending about a perimeter encompassing the first wire trace circuit layer and extending through the printed circuit board first layer, extending through and exposing the first wire trace circuit layer; extending through the first insulation layer and extending to the reference plane exposing the reference plane; and a conducting plating layer on the interior wall electrically connecting the first wire traces layer to the ground plane; wherein the perimeter encompasses a portion of the first trace circuit layer (141b, 141c).

It has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations pertaining to phrase "for fixing a potential reference for a plurality of wiring circuit trace layers that are electrically isolated there between by a plurality of printed circuit board layers and having a printed circuit board first layer with a main surface". Ex Pane Masham, 2USPQ F.2d 1647 (1987).

As to claim 20, since the method of manufacturing the device is merely a list of steps of forming, these steps must be performed in order to obtain the device (see rejection of claims 2, 9-12 above). Therefore, the method of manufacturing would be inherent to the shown structure of the device.

As to claims 21-22, Harada et al. disclose in Fig. 3 an EMI shielding structure comprising: a printed circuit board having a plurality of wire trace circuit layer (141b, 141c) and a

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plurality of printed circuit board insulation layers there between and having a plurality of printed circuit board edges and a ground plane (140); and a first trench (on the right hand side) having an interior wall and extending in parallel with the board edge within a perimeter defined by the board edge encompassing the printed circuit board wire circuit trace and extending through the printed circuit board layers and extending to the ground plane, exposing the ground plane; and electrically conductive plating material (141a, 141d) applied over the interior wall there through and electrically connecting to the exposed ground plane providing at least a partial perimeter shield for the printed circuit board.

It has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations pertaining to phrase "for shielding a plurality of wire circuit trace layers that are electrically isolated by printed circuit board layer". Ex Pane Masham, 2USPQ F.2d 1647 (1987).

As to claim 23, a second trench (on the left hand side) having an interior wall and extending wholly within and in parallel with an outer perimeter defined by the first trench and extending through the printed circuit board layers and extending to the ground plane exposing the ground plane; wherein the second interior wall is plated with electrical conductive plating material (141a, 141d) applied over the interior wall there through and electrically connecting to the exposed ground plane.

# Claim Rejections - 35 USC § 103

9. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the

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invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

10. Claims 3-4 alternatively are rejected under 35 U.S.C. 103(a) as being unpatentable over Kamperman et al. [US 5,734,560] in view of Sen et al.

Kaperman et al. disclose in Figs. 1-2 (also see attachment) a wiring connection structure for a printed circuit board, characterized by: a first wire trace applied to a main surface having a first terminal land pad with a first through hole there through-hole; a printed circuit board first insulation layer formed over the first wire trace having a second through hole of identical cross sectional geometry and vertically aligned with the first through hole and extending to the first terminal landing pad exposing a portion of the first land pad; and a second wire trace applied to the printed circuit board first insulating layer having a second terminal landing pad; wherein the first and second through holes are adjoining and are plated there through with an electrically conductive material forming a plated through hole; wherein the vertically intersects the first and second terminal pads and electrically connects the first wire trace and the second wire trace by a connection between the first and second wire trace terminal landing parts and the plated through hole. Kaperman et al. disclose only two through holes are connected. However, it would have been obvious to one of ordinary skill in the art at the time of the invention was made to employ more than two through holes (i.e. another third through hole having identical geometry with the first and second through holes, as Kaperman et al. taught in col. 1, lines 48-50 or col. 2, lines 47-50) in order to improve surface for mounting electronic device. Kaperman et al. do not disclose the through hole having a convoluted shaped cross section.

Sen et al. disclose in Figs. 3A-F a through hole has a shaped continuos curve cross section. It would have been obvious to one of ordinary skill in the art at the time of the invention was made to employ the through hole having a convoluted shaped cross section, as Sen et al. in order to have a characteristic inductance property.

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It has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations pertaining to phrase "for interconnecting wiring circuit traces applied on a plurality of printed circuit board layers and electrically isolated by the printed circuit board layers and having a printed circuit board first layer with a main surface". Ex Pane Masham, 2USPQ F.2d 1647 (1987).

11. Claim 5-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kaperman et al. in view of Sen et al. as applied to claims 3-4 above, and further in view of Mattei [US 5,522,132].

Kaperman et al. and Sen et al. disclose all claimed subject matter except for the continuos curved cross section is "U" shaped.

Mattei discloses in Fig. 5 the continuous curved cross section "U" shaped.

It would have been obvious to one of ordinary skill in the art at the time of the invention was made to employ the through hole having U shaped, as taught by Mattei, in order to reduce insertion loss and return loss and to improve isolation.

As to claims 6-8, Kamperman et al., Sen et al. and Mattei disclose(s) the claimed subject matter except for the through hole having the "L" shaped/ "+" shaped. It would have been obvious matter of design choice to "L" shaped, "+" shaped, since applicant has not disclose the "U" shaped, "L" shaped, "+" shaped solves any stated problem or is for any particular purpose and it appears that the invention would perform equally well with convoluted shaped i.e. "U" shaped.

12. Claims 18-19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Sen et al.

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Sen et al. disclose all claimed subject matter except for plasma ablation/laser method. However, it well known in the art to using the plasma ablation or laser method, as Applicant discloses in the specification on page 2-3.

13. Claims 24-26 are rejected under 35 U.S.C. 103(a) as being unpatentable over Harada et al. in view of Inoue et al. [US 5,270,493].

Harada et al., disclose all claimed subject matter except for an EMC sensitive track of conductive material.

Inoue et al. disclose in Fig. 2 an EMC sensitive track (7) of conductive material extending and parallel with an outer perimeter defined by the first elongated through-hole (8) and disposed between circuit board insulating layer (2, 3) through which the trenched through-hole extends.

It would have been obvious to one of ordinary skill in the art at the time of the invention was made to employ the EMC sensitive track, as taught by Inoue et al., for the benefit of reducing an electromagnetic wave.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Quynh-Nhu H. Vu whose telephone number is 703-305-0850. The examiner can normally be reached on 7:30-5:00 (M-F).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Jeffrey Gaffin can be reached on 703-308-3301. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7724 for regular communications and 703-308-7722 for After Final communications.

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Page 11

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

QNV September 28, 2001 U.S. Patent

May 9, 1995

Sheet 2 of 2

5,414,222

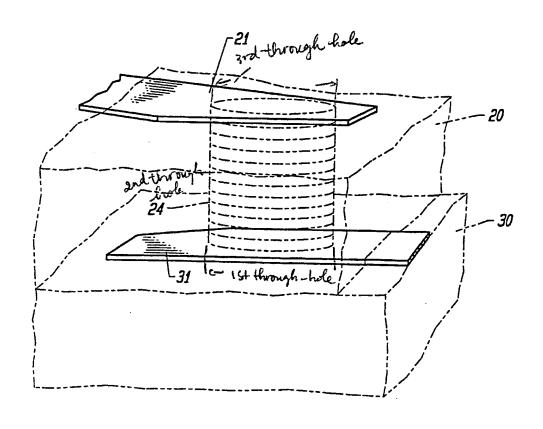
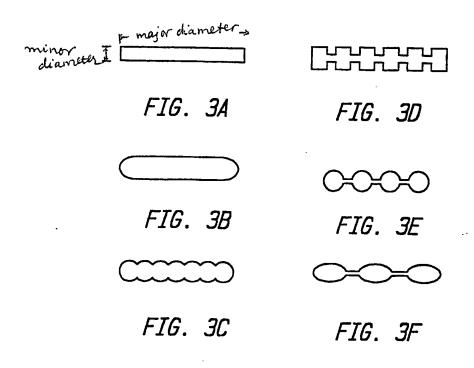


FIG. 2

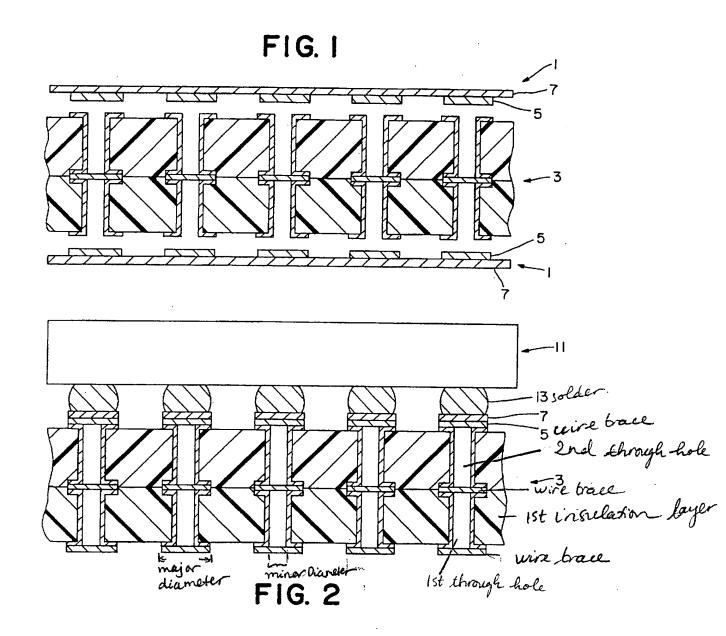


'AUG 2 2006

U.S. Patent

Mar. 31, 1998

5,734,560



AUG 2 2006

Application/Control No.

O9/786,787

Applicant(s)/Patent Under Reexamination COTTON, MARTIN A.

Examiner

Quynh-Nhu H. Vu

Applicant(s)/Patent Under Reexamination COTTON, MARTIN A.

Page 1 of 1

# U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification	
	Α	US-5,270,493	12-1993	Inoue et al.	174	253
	В	US-5,966,294	10-1999	Harada et al.	361	794
	С	US-				
	D	US-				
	Ε	US-				
	F	US-				
	G	US-				
	Н	US-				
		US-				
	J	US-				
-	К	US-				
	L	US-				
	М	US-				

## FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	nt Number Date Lumber-Kind Code MM-YYYY Country Name		Classification	
	N					
	0					
	Р				J. J	
	Q					
	R					
	S					
	Т					

## **NON-PATENT DOCUMENTS**

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	υ	·
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	W	
	х	

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).) Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.